

2SK1764 Silicon N Channel MOS FET

REJ03G0970-0200 (Previous: ADE-208-1317) Rev.2.00 Sep 07, 2005

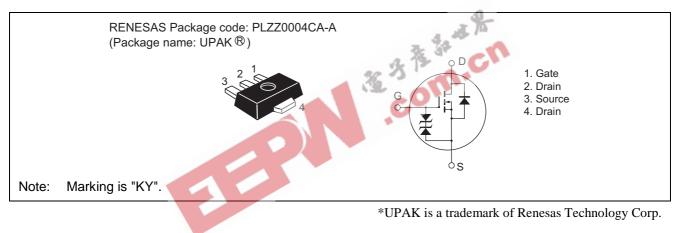
Application

- Low frequency amplifier
- High speed switching

Features

- Low on-resistance
- High speed switching
- 4 V Gate drive device can be driven from 5 V source
- Suitable for switching regulator, DC-DC converter

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$ Unit	
ltem	Symbol	Ratings		
Drain to source voltage	V _{DSS}	60	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	I _D	2	А	
Drain peak current	I _{D(pulse)} *1	4	А	
Body to drain diode reverse drain current	I _{DR}	2	А	
Channel power dissipation	Pch∗₂	1	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW \leq 100 μ s, duty cycle \leq 10 %

2. Value on the alumina ceramic board (12.5 x 20 x 0.7 mm)

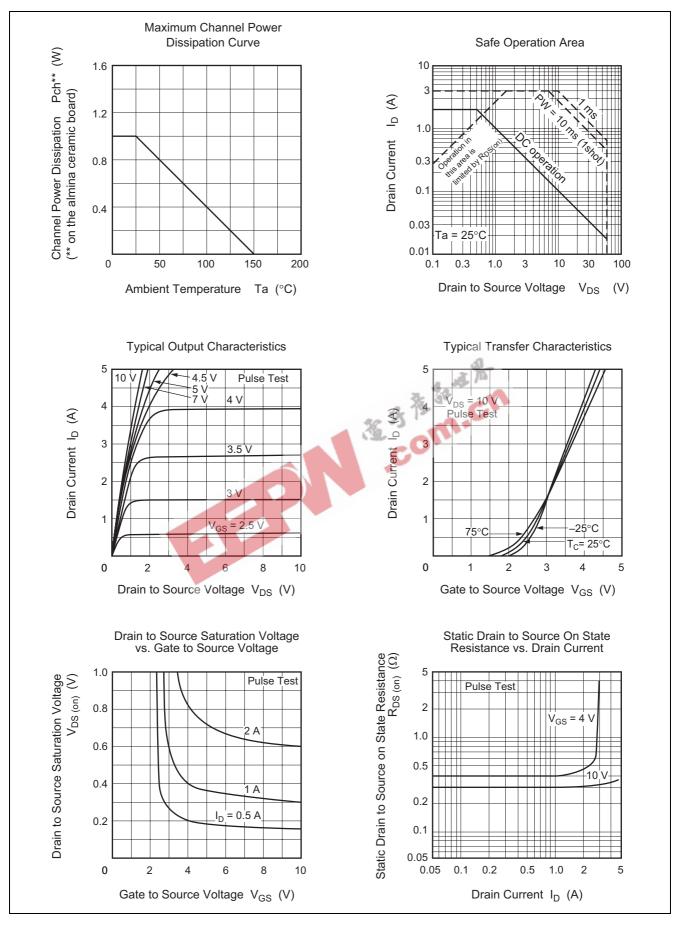
Electrical Characteristics

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	60		_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	_		V	$I_G = \pm 100 \ \mu A, V_{DS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1	_	2	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Drain to source cutoff current	I _{DSS}	_	_	10	μΑ	$V_{DS} = 50 \text{ V}, V_{GS} = 0$
Gate to source cutoff current	I _{GSS}	_	_	±5	μA	$V_{GS} = \pm 15 \text{ V}, \text{ V}_{DS} = 0$
Static drain to source on state	R _{DS(on)1}	_	0.3	0.45	Ω	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}^{*3}$
resistance			- %.	3		
Static drain to source on state	R _{DS(on)2}	-	0.4	0.60	Ω	$V_{GS} = 4 V, I_D = 1 A^{*3}$
resistance				6		
Forward transfer admittance	y fs	0.9	1.7	_	S	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}^{*3}$
Input capacitance	Ciss	777	140	_	рF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss		75	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	—	20	_	рF	
Turn on time	t _{on}	_	18	_	ns	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}^{*3},$
Turn off time	t _{off}	_	80	_	ns	$R_L = 30 \Omega$

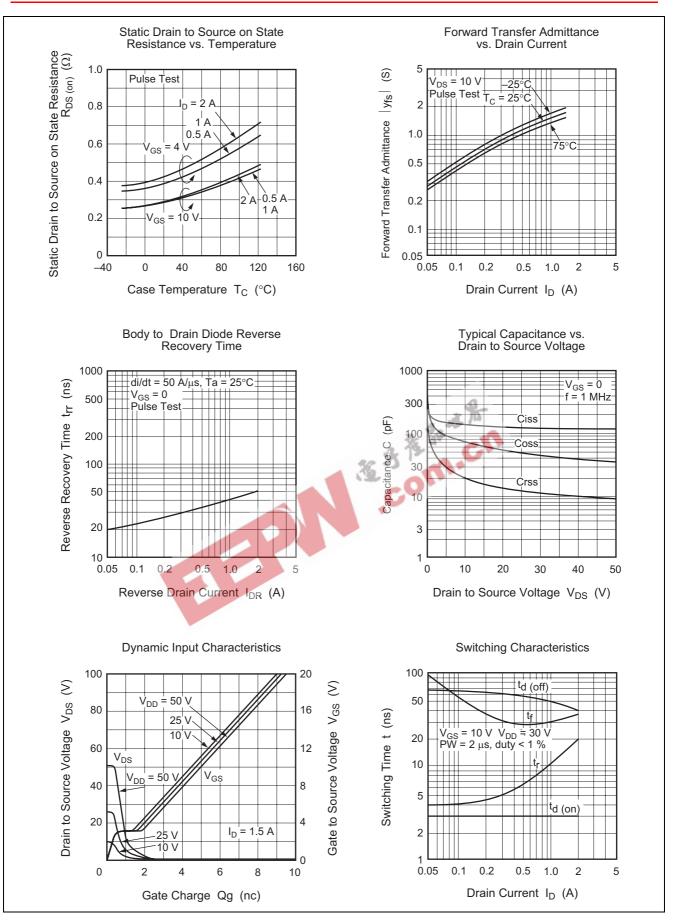
Note: 3. Pulse Test



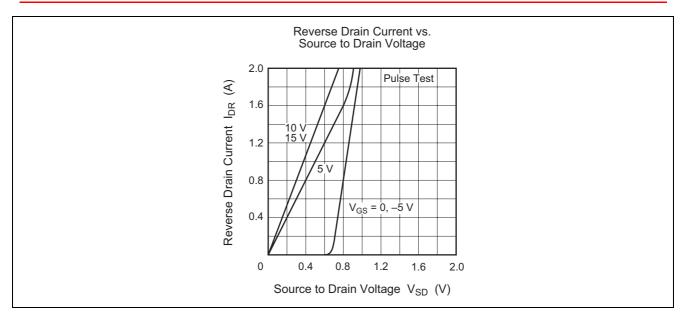
Main Characteristics







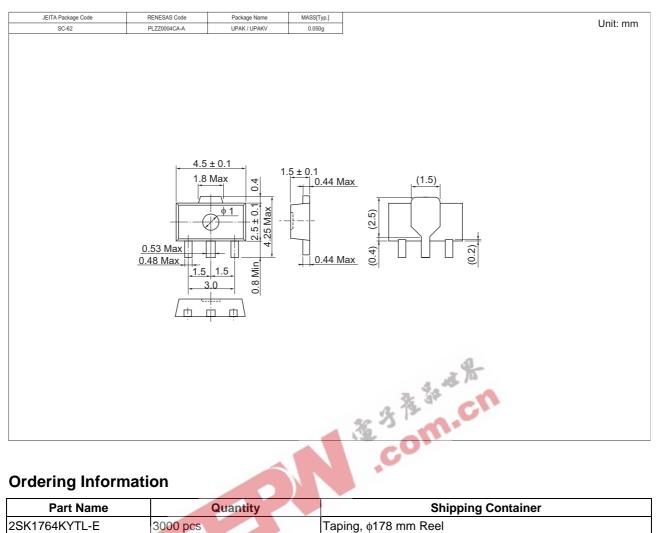








Package Dimensions



 2SK1764KYTR-E
 3000 pcs
 Taping, \u03c6178 mm Reel

 Note:
 For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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